

## C0603C361G1HACTU

Aliases (C0603C361G1HAC7867)

SMD Comm X8R HT150C, Ceramic, 360 pF, 2%, 100 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 0603



Click [here](#) for the 3D model.

Dimensions	
Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.07mm
S	0.7mm MIN
B	0.35mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

General Information	
Series	SMD Comm X8R HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	4800 ug
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	360 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	2%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	X8R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1MHz 1.0Vrms
Dissipation Factor	2.5% 1MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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